

LMH0202 Dual SMPTE 292M / 259M Serial Digital Cable Driver

Check for Samples: LMH0202

FEATURES

- SMPTE 292M, SMPTE 344M and SMPTE 259M Compliant
- Data Rates to 1.485 Gbps
- Dual Differential Inputs
- Dual 75Ω Differential Outputs
- Two Selectable Slew Rates
- Adjustable Output Amplitude
- Single 3.3V Supply Operation
- Commercial Temperature Range: 0°C to +70°C
- Typical Power Consumption: 250 mW in SD Mode and 300 mW in HD Mode

APPLICATIONS

- SMPTE 292M, SMPTE 344M, and SMPTE 259M Serial Digital Interfaces
- DVB-ASI Applications
- Sonet/SDH and ATM Interfaces
- Digital Routers and Switches
- Distribution Amplifiers
- Buffer Applications
- Video Cameras

Connection Diagram

DESCRIPTION

The LMH0202 Dual SMPTE 292M / 259M serial digital cable driver is a monolithic, high-speed cable driver designed for use in SMPTE 292M / 259M serial digital video and ITU-T G.703 serial digital data transmission applications. The LMH0202 drives 75Ω transmission lines (Belden 8281, Belden 1694A or equivalent) at data rates up to 1.485 Gbps.

The LMH0202 provides two selectable slew rates for SMPTE 259M and SMPTE 292M compliance. The output voltage swing is adjustable via a single external resistor.

The LMH0202 offers the flexibility to implement either dual differential inputs or a single differential input (externally routed via PCB) to dual differential outputs. The latter option provides an ideal solution for DVB-ASI applications where only the non-inverted outputs are typically used.

The LMH0202 is powered from a single 3.3V supply. Power consumption is typically 250 mW in SD mode and 300 mW in HD mode.

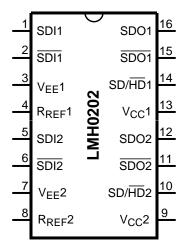


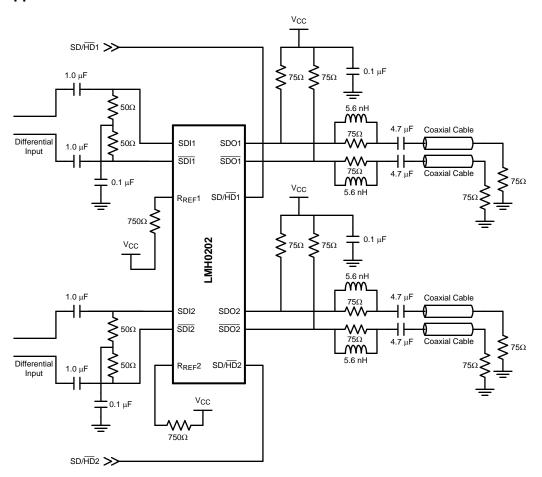
Figure 1. 16-Pin TSSOP See PW Package

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Typical Application







These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings(1)

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Supply Voltage:	-0.5V to 3.6V
Input Voltage (all inputs)	-0.3V to V _{CC} +0.3V
Output Current	28 mA
Storage Temperature Range	-65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (Soldering 4 Sec)	+260°C
Package Thermal Resistance θ_{JA} 16-pin TSSOP θ_{JC} 16-pin TSSOP	+125°C/W +105°C/W
ESD Rating (HBM)	5 kV
ESD Rating (MM)	250V

Absolute Maximum Ratings are those parameter values beyond which the life and operation of the device cannot be ensured. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of Electrical Characteristics specifies acceptable device operating conditions.

Recommended Operating Conditions

Supply Voltage (V _{CC} – V _{EE}):	3.3V ±5%
Operating Free Air Temperature (T _A)	0°C to +70°C

DC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified (1)(2).

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
V_{CMIN}	Input Common Mode Voltage		SDI1, SDI1, SDI2, SDI2	1.6 + V _{SDI} /2		V _{CC} – V _{SDI} /2	V
V_{SDI}	Input Voltage Swing	Differential		100		2000	mV_{P-P}
V_{CMOUT}	Output Common Mode Voltage		SDO1, SDO1,		V _{CC} – V _{SDO}		V
V _{SDO}	Output Voltage Swing	Single-ended, 75Ω load, $R_{REF}1 = 750\Omega$ 1%, $R_{REF}2 = 750\Omega$ 1%	SDO2, SDO2	750	800	850	mV_{P-P}
		Single-ended, 75Ω load, $R_{REF}1 = 590\Omega$ 1%, $R_{REF}2 = 590\Omega$ 1%		900	1000	1100	mV_{P-P}
V_{SDHD}	SD/HD Input Voltage	Min for SD	SD/HD1,	2.4			V
		Max for HD	SD/HD2			0.8	V
I _{SDHD}	SD/HD Input Current				3.7		μA
I_{CC}	Supply Current	$SD/\overline{HD}1 = 0$, $SD/\overline{HD}2 = 0^{(3)}$			90	98	mA
		$SD/\overline{HD}1 = 1$, $SD/\overline{HD}2 = 1^{(3)}$			76	86	mA

Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to $V_{EE} = 0$ Volts.

Typical values are stated for V_{CC} = +3.3V and T_A = +25°C. Maximum I_{CC} is measured at V_{CC} = +3.465V and T_A = +70°C.



AC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified (1).

Symbol	Parameter	Conditions	Reference	Min	Тур	Max	Units
DR _{SDI}	Input Data Rate		(2)SDI1, <u>SDI1</u> , SDI2, <u>SDI2</u>			1485	Mbps
t _{jit}	Additive Jitter	1.485 Gbps	SDO1, <u>SDO1</u> ,		26		ps _{P-P}
		270 Mbps	SDO2, SDO2		18		ps _{P-P}
t _r ,t _f	Output Rise Time, Fall Time	$SD/\overline{HD}1 = 0$, $SD/\overline{HD}2 = 0$, $20\% - 80\%^{(3)}$			120	220	ps
		$SD/\overline{HD}1 = 1$, $SD/\overline{HD}2 = 1$, $20\% - 80\%^{(3)}$		400	560	800	ps
	Mismatch in Rise/Fall Time	(2)				30	ps
tos	Output Overshoot	(2)				8	%
RL _{SDO}	Output Return Loss	(4)		15	20		dB

Typical values are stated for V_{CC} = +3.3V and T_A = +25°C. Specification is ensured by characterization. Specification is ensured by characterization and verified by test. Output return loss is dependent on board design. The LMH0202 meets this specification on the SD202 evaluation board from 5 MHz to 1.5 GHz.



Table 1. PIN DESCRIPTIONS

Pin #	Name	Description
1	SDI1	Serial data true input.
2	SDI1	Serial data complement input.
3	V _{EE} 1	Negative power supply (ground).
4	R _{REF} 1	Output driver level control. Connect a resistor to V_{CC} to set output voltage swing.
5	SDI2	Serial data true input.
6	SDI2	Serial data complement input.
7	V _{EE} 2	Negative power supply (ground).
8	R _{REF} 2	Output driver level control. Connect a resistor to V_{CC} to set output voltage swing.
9	V _{CC} 2	Positive power supply (+3.3V).
10	SD/HD2	Output slew rate control. Output rise/fall time complies with SMPTE 292M when low and SMPTE 259M when high.
11	SDO2	Serial data complement output.
12	SDO2	Serial data true output.
13	V _{CC} 1	Positive power supply (+3.3V).
14	SD/HD1	Output slew rate control. Output rise/fall time complies with SMPTE 292M when low and SMPTE 259M when high.
15	SDO1	Serial data complement output.
16	SDO1	Serial data true output.

DEVICE OPERATION

INPUT INTERFACING

The LMH0202 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. SDI and $\overline{\text{SDI}}$ are self-biased at approximately 2.1V with $V_{\text{CC}} = 3.3$ V. Figure 2 shows the differential input stage for SDI and $\overline{\text{SDI}}$.

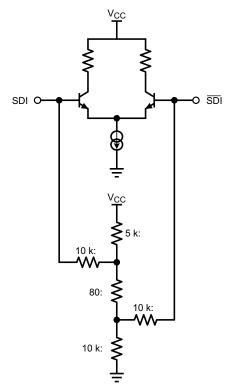


Figure 2. Differential Input Stage for SDI and SDI.



DVB-ASI APPLICATIONS

The dual differential inputs of the LMH0202 may be externally routed to a single differential input as shown in Figure 3. This provides a solution for DVB-ASI applications where two non-inverted outputs are needed.

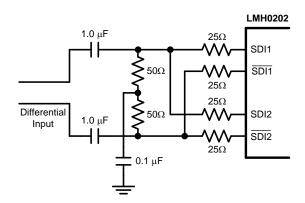


Figure 3. Single Differential Input for DVB-ASI

OUTPUT INTERFACING

The LMH0202 uses current mode outputs. Single-ended output levels are 800 mV_{P-P} into 75 Ω AC-coupled coaxial cable (with R_{REF} = 750 Ω). Output level is controlled by the value of the resistor connected between the R_{REF} pin and V_{CC}.

The R_{REF} resistor should be placed as close as possible to the R_{REF} pin. In addition, the copper in the plane layers below the R_{REF} network should be removed to minimize parasitic capacitance.

OUTPUT SLEW RATE CONTROL

The LMH0202 output rise and fall times are selectable for either SMPTE 259M or SMPTE 292M compliance via the SD/HD pin. For slower rise and fall times, or SMPTE 259M compliance, SD/HD is set high. For faster rise and fall times, or SMPTE 292M compliance, SD/HD is set low.



REVISION HISTORY

CI	hanges from Revision B (April 2013) to Revision C	Page
•	Changed layout of National Data Sheet to TI format	6

11-Nov-2025 www.ti.com

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
LMH0202MT/NOPB	Active	Production	TSSOP (PW) 16	92 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	L202
LMH0202MT/NOPB.A	Active	Production	TSSOP (PW) 16	92 TUBE	Yes	SN	Level-1-260C-UNLIM	0 to 70	L202
LMH0202MT/NOPB.B	Active	Production	TSSOP (PW) 16	92 TUBE	-	Call TI	Call TI	0 to 70	

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TUBE

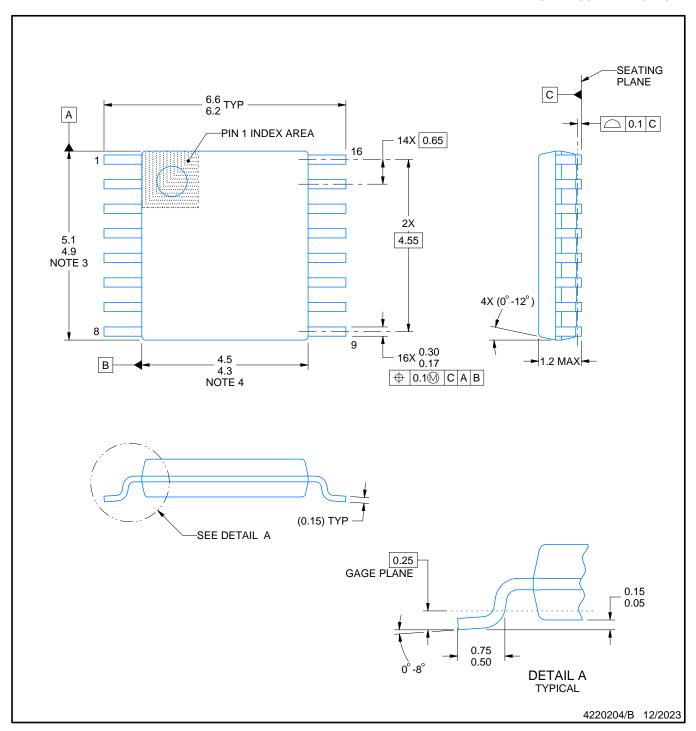


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
LMH0202MT/NOPB	PW	TSSOP	16	92	495	8	2514.6	4.06
LMH0202MT/NOPB.A	PW	TSSOP	16	92	495	8	2514.6	4.06



SMALL OUTLINE PACKAGE



NOTES:

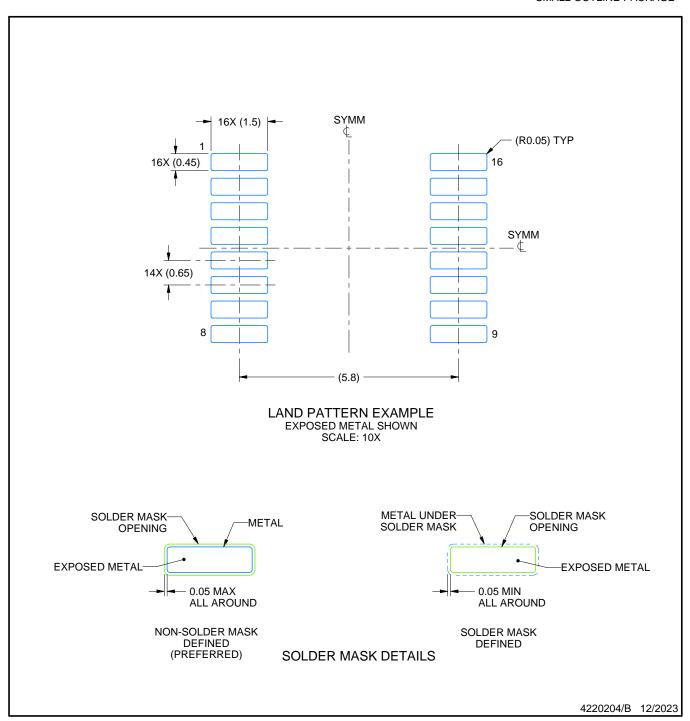
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE

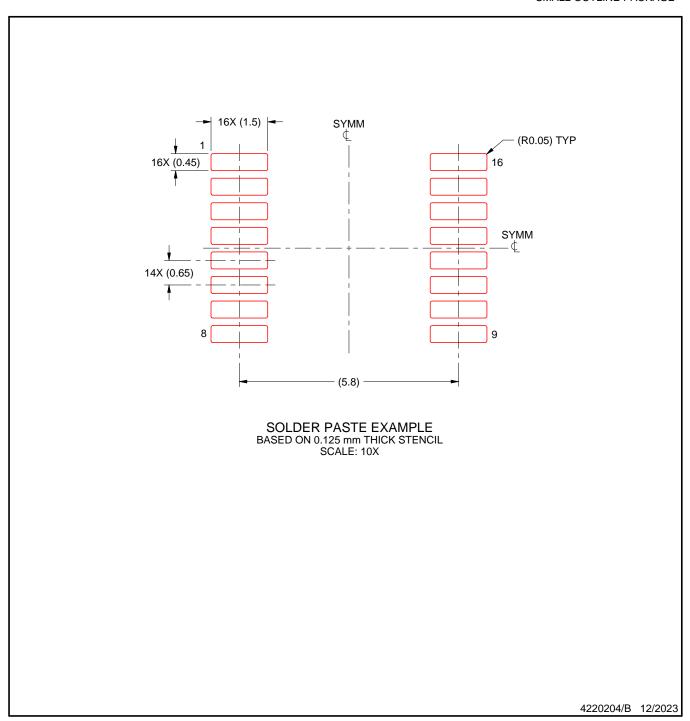


NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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